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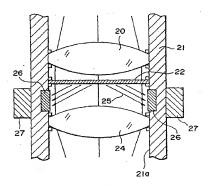
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(54) Projection optical system for projection exposure apparatus

(57) An optical unit and an optical instrument having the same, wherein the unit includes an optical element for deflecting light incident thereon toward different directions, and an attenuating device for attenuating light deflected in a predetermined direction, of the different directions.



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#### FIELD OF THE INVENTION AND RELATED ART

[0001] This invention relates to an optical unit having an optical element such as a diffractive optical element, for example, and, more particularly, to an optical unit suitably usable in manufacture of a microdevice such as IC or LSI, for example.

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[6002] Semiconductor device manufacturing technology has recently been advanced remarkably and, in this trend, microprocessing techniques have been developed significantly. For the microprocessing, reduction projection exposure apparatuses having a resolving power of submicron order and being called steppers are mainly used. For further improvement of resolution, enlargement of the numerical aperture (NA) of an optical system, shortening of exposure wavelength or introduction of novel ootical element has been attempting.

(9003) An optical element such as a diffractive optical a selement may be used in an exposure apparatus for correction of chromatic aberration, for example. In that ocasion, among light rays (unwanted light) diffracted in directions other than a desired direction or directions may be reflected within a lens barrel, by which ghost or flare may be produced. This may cause non-uniformness of exposure amount distribution upon the surface to be exposed.

#### SUMMARY OF THE INVENTION

[0004] It is an object of the present invention to provide an improved optical unit by which such ghost or flare can be reduced or avoided.

[0005] It is another object of the present invention to provide an optical instrument having such optical unit as described above.

[0006] In accordance with an aspect of the present invention, there is provided an optical unit, comprising an 40 optical element for deflecting light incident thereon toward different directions; and attenuating means for attenuating light deflected in a predetermined direction, of the different directions.

[0007] In accordance with another aspect of the 45 present invention, there is provided an optical fund; comprising means for holding an optical element being operable to deflecting a period of light incident thereon toward a predetermined direction and and having a function that an unwanted light in another portion of the fight incident thereon is directed in a direction different from the predetermined direction; and attenuating means operable to converge at least a portion of the unwanted light toward a predetermined region through multiple reflection, thereby to attenuate the same.

[0008] In one preferred form of these aspects of the present invention, there is cooling means for cooling said attenuating means.

[0009] The attenuating means may have a function for converging the light toward a predetermined region through multiple reflection.

[0010] The optical element may comprise a diffractive optical element,

[0011] The diffractive optical element may have a diffraction pattern formed with a step-like shape.

[0012] The light deflected toward the predetermined direction may be a positive first order or negative first order diffraction light of the light deflected by said optical element.

[0013] The attenuating means may comprise light absorbing means having a recess of hom-like sectional shape with its inside wall face formed as a reflection sur-

[0014] The attenuating means may comprise light absorbing means having a groove-like member with its side face formed as a reflection surface.

[0015] The optical element may be fixedly or movably to held in a barrel, wherein said alternuating means may be provided over the whole circumference of the inside circumferential surface of said barrel.

[0016] The optical unit may have a plurality of light absorbing means.

25 [90.17] The cooling means may comprise an air cooling system, a water cooling system, or a Petitler device. [0018] in accordance with a further a space of the present invention, there is provided an optical instrument having an optical unit as reclied above, of projection in glight to a photosensitive material through said optical unit.

[0019] In accordance with a yet further aspect of the present invention, there is provided an optical instrument having an optical unit as recited above, for projecting light to a photoelectric converting element through said optical unit.

[0020] In accordance with a sill further aspect of the present invention, there is provided an exposure apparatus, comprising: an illumination optical system; a projection optical system; and an optical unit as rectad above, wherein said optical unit is incorporated into one of said illumination optical system and said projection optical system as a portion threed, so that a prodetermined pattern is projected onto a surface to be illuminated, whereby the pattern is printed thereony.

[0021] In accordance with a yet further aspect of the present invention, there is provided a device manufacturing method, comprising the steps of.

applying a photosensitive material to a wafer, exposing the wafer having the photosensitive material applied thereto, with a device pattern by use of an exposure apparatus as recited in Claim 17; and developing the exposed wafer.

[0022] These and other objects, features and advanfor tages of the present invention will become more apparent upon a consideration of the following description of the preferred embodiments of the present invention taken in conjunction with the accompanying drawings.

#### BRIEF DESCRIPTION OF THE DRAWINGS

#### [0023]

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Figure 1 is a schematic view of a general structure of a stepper according to a first embodiment of the present invention.

Figure 2 is a schematic and sectional view of a portion of a reduction optical system according to an embodiment of the present invention.

Figures 3A and 3B are schematic views of an optical unit according to an embodiment of the present invention

Figure 4 is a schematic and sectional view, showing in enlargement a portion of a reduction optical system according to an embodiment of the present in-

Figure 5 is a schematic and sectional view, showing details of an optical absorption structure according to an embodiment of the present invention.

Figure 6 is a schematic and sectional view, showing in enlargement a portion of a reduction optical system according to another embodiment of the present invention.

Figure 7 is a schematic and sectional view, showing details of an optical absorption structure according to another embodiment of the present invention. Figure 8 is a schematic and sectional view, showing

Figure 9 is a schematic and sectional view, showing a portion of a reduction optical system according to a further embodiment of the present invention.

Figure 9 is a schematic and sectional view of a television camera according to an embodiment of the present invention.

Figure 10 is a flow chart of semiconductor device manufacturing processes, using a stepper according to the present invention.

Figure 11 is a flow chart for explaining details of a wafer process in the procedure of Figure 10.

Figure 12 is a schematic and sectional view showing in enlargement a portion of a reduction optical 40 system according to a further embodiment of the present invention.

Figure 13 is a schematic and sectional view, showing details of an optical absorption structure according to a further embodiment of the present invention.

### DESCRIPTION OF THE PREFERRED

### **EMBODIMENTS**

[0024] Preferred embodiments of the present invention will now be described with reference to the accompanying drawings.

[0025] Figure 1 is a schematic and side view of a general structure of a stepper (reduction projection exposure apparatus) having an optical unit according to a first embodiment of the present invention. Figure 2 is a schematic and sectional view of a portion of a projection op-

tical system in the stepper of Figure 1.

[0026] Figure 1 is a schematic view which shows a major structure of the stopper of the first embodiment, wherein the stepper comprises an illumination optical system 10 for projecting an illumination light to a reticle 11 having a circuit pattern formed thereon, and a projection optical system 12 for projecting the pattern of the reticle 11 not he surface of a water 13 in a reduced scale, by use of the light passing through the reticle 11. The stepper further comprises a waifer chuck 14 or which the wafer 13 is placed and held fixed, and a wafer stage 15 on which the wafer chuck 14 is fixedly mount-

[0027] The optical system described above comprises a light source 1 for emitting illumination light of shortwavelength light such as ultraviolet light or deep ultraviolet light (in this embodiment, high-luminance ArF excimer laser light), and beam shape changing means 2 for transforming the illumination light from the light source I into a desired beam shape. It lurther comprises an optical integrator 3 having a plurality of cylindrical lenses or small lenses disposed two-dimensionally, and a stop member 4 having interchangeable stops which can be selectively interchanged by using interchanging means (not shown), and being disposed adjacent to the position of secondary light sources as produced by the optical integrator 3. The optical system further comprises a condenser lens 5 for collecting the illumination light passed through the stop member 4, and a blind means 7 having four movable blades, for example, and being disposed at a conjugate plane of the reticle 11 to determine a desired illumination range on the reticle 11 surface. It further comprises an imaging lens 8 for projecting the illumination light having been determined by the blind 7, into a predetermined shape, and a deflection mirror 9 for reflecting the illumination light, from the imaging lens 9, toward the reticle 11 direction.

[0028] The operation for projecting, in a reduced scale, the pattern of the reticle 11 onto the wafer 13 surof face by using the stepper of the structure described above, will be explained.

[0029] First, the illumination light emitted from the tight source 1 is transformed by the beam shape changing means 2 into a predetermined shape and, after this, it is projected onto the optical integrator 3. In response, adjacent to the light exit surface of the integrator, a plurality of secondary light sources are produced. The illumination light from these secondary light sources pass through the stop member 4 and are collected by the condenser lens 5. Then, after being defined into a predetermined shape by means of the blind 7, the light is transmitted through the imaging lens 8 and is reflected by the deflection mirror 9. Subsequently, the light passes the pattern of the reticle 11 and it enters the projection optical system 12. The light passes through the projection optical system 12, by which the reticle pattern is projected upon the surface of the water 11 while being reduced into a predetermined size. The water exposure is

thus performed

[0030] The structure of the projection optical system 12 having an optical unit with a diffractive optical element 22 according to the first embodiment, will be described below. Figure 2 is a sectional view of a potion of the projection optical system 12 of Figure 1. There is a diffractive optical element 22 fixedly mounted inside a barrel 21. Also, there are lenses 20 and 24 fixedly disposed above and below the diffractive optical element 22.

[0031] The diffractive optical element 22 is a single unit having a function equivalent to a combination of plural lenses being accumulated, and it serves to reduce aberration of the projection optical system 12, particulariv. chromatic aberration thereof.

[0032] Namely, with the insertion of the diffractive optical element 22 into the projection optical system 12, production of aberration can be reduced to minimum while using a decreased number of optical lenses of the projection optical system 12.

[0033] Next, details of the diffractive optical element 22 will be explained. Figure 3A is a plan view of the diffractive optical element 22, and Figure 3B is a fragmentary sectional view taken on a line I-I in Figure 3A.

[0034] As shown in Figure 3A, the diffractive optical 25 element 22 is formed into a disk-like shape to be fitted into the inside diameter of the barrel 21. Further, as shown in Figure 3B, there is a diffraction grating surface 22a of small step-like sectional shape formed on the diffractive optical element.

[0035] Thus, the diffractive optical element is a binary type optical element with a diffraction grating surface 22a which can be produced by forming small surface steps (level differences). Through the function of these small surface steps, the diffractive optical element op-greates to diffract light rays 23 incident thereon, at a desired deflection angle.

[0036] The difractive optical element 22 can be produced by microprocessing a delst-like substrate, mainly consisting of quartz, on the basis of a photolithographic 40 process and a dry etching process, used in the semiconductor manufacturing procedure. The diffraction grating surface 22a thereof is formed into such shape that an idealistic element shape (blazed shape) as depicted in Figure 3B is approximated by a step-like shape. 45 Here, the height (level difference) of each individual step in the step-like section is about 40 - 60 mm.

[0037] A diffraction pattern on the diffraction grating surface 22 ac an be produced by patterning the surface of a dek-like substrate on the basic of photolithography 40 and dry ethning, In order to provide a diffraction pattern with a step-like shape such as shown in Figure 3B, patterning operations of limes corresponding to the number of surface steps are necessary. When a diffraction pattern with eight steps (levels) such as shown in Figure 45 3B is to be produced, three times patterning operations are necessary. Here, if a disk-like substrate which is a raw material for the diffractive optical element 22 is rel-

atively large in size, the whole range may not be exposed through a single exposure operation. Thus, the element surface may be divided concentrically into plural zones, and three times patterning operations may be performed with respect to each of the zones.

[0038] As shown in Figure 3B, the light rays 23 incident on the diffractive optical element 22 are diffracted thereby at a desired deflection angle, so that light rays 24 (i.e., first order diffraction light) to be used for the image pickup are produced. Here, most of the incident light rays 23 are diffracted as desired first order diffraction light. However, there are unwanted light rays 25 produced by diffraction, which advance in a direction different from the advancement direction of the light rays 24. [0039] The light rays 25 are those rays which are produced in relation to the small surface steps (level differences) of the binary type optical element. If the diffraction grating surface 22a of the diffractive optical element 22 is formed into a completely idealistic shape, there occurs no such unwanted light ray 25. However, when the diffraction grating surface 22a is approximated by use of a small step-like structure, unwanted light rays 25 are produced. In accordance with simulations based on design values of the diffraction grating surface 22a of the diffractive optical element 22 as well as the wavelength of light rays projected thereto from the light source 1, for example, the advancement direction (diffraction angle) of the first order diffraction light (light rays 24) and also the advancement direction (diffraction angle) of the un-

wanted light rays 25, can be detected. [0040] Next, the structural members provided in the barrel 21, for absorbing the unwanted light 25, will be exclained.

[0041] As shown in Figure 2, upon the inside circumlerential surface 21a of the barrel 21 between the diffractive optical element 22 and the optical lens 24, there is a light absorbing structure (attenuating means) 26 xtending over the entire circumference. Disposed close to the light absorbing structure 26 and outside the barrel 21 is cooling means 27 which extends over the entire circumference.

[0042] Figure 4 shows datalts of the light absorbing structure 28 in the first embodiment. The light absorbing structure 28 comprises two recesses 28 and 29 formed close to each other and each having a hom-like sectional shape. Each of these hom-like recesses 28 and 29 is formed to extend over the entire inside circumference of the barriel 21. The positions of the recesses 28 and 29 are just below the diffractive optical element 22 and they are on an extension line of the advancement direction of the unwanted light 25.

(0043) The barrel is made of metal, for example, and the niner wall surfaces of the recesses 28 and 29 are formed as metal effection surfaces. Figure 5 is a sectional view, showing the shape of the recess 28 in detail. The recess 28 is formed with a hom-like sectional shape. Thus, the niner wall surface 28a of the recess 28 is bent upwardly, as viewed in Figure 4, and its free

end portion 2Bb is converged loward a particular region.
[004] Figure 5 illustrates that the unwanted light 25
entering the recess 2B is reflected within the recess 2B.
In this manner, the unwanted light rays 25 are reflected
by the inner wall surface 2Ba of the recess 2B loward 5
the bottom of the recess, and they are converged to the
free end portion 2Bb at the bottom of the recess 2B
[0045] Thus, with the provision of the horn-like recess
2B disposed in the advancement direction of the unwanted lights 25, the unwanted lights can be converged
10 toward a particular convergence region through multiple
reflection inside the recess 2B, and they can be ab-

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[0046] As shown in Figure 4, there is cooling means 27 comprising Peltier elements 30a and 30b which are 15 provided outside the barret 21 and in close proximity to the free and portions 28b and 29b of the recesses 28 and 29 Thoses Peltier elements 30a and 30b function to absorb tent on the basis of the Peltier effect.

sorbed thereby

[0047] By disposing the Poter elements 30e and 30b and cose presently to the free one portions 28b and 28b of the recesses 28 and 29 ery heat generation to be produced at the free and portions 28b and 29b in response to the absorption of unwanted light 25, can be cooled from the outside of the barried 21. As a result of all any deformation of the barried 21 due to heat peneration at the recesses 28 and 29 can be prevented and, therefore, degradation of optical performance of the projection optical system 12 due to such deformation of the barried 21 can be avoided.

[0048] In accordance with the first embodiment of the

present invention as described above, light rays 23 incident on the diffractive optical element 22 are diffracted into desired first order diffraction light (light rays 24). while unwanted light rays 25 produced and diffracted in a direction different from the light rays 24 are absorbed by horn-like recesses 28 and 29 which are provided in the advancement direction of the unwanted light rays 25. Through the absorption of the unwanted light 25, it can be removed from the projection optical system 12 [0049] As a result, the light rays 25 which may cause irregular reflection within the projection optical system 12 can be removed and, therefore, production of ghost or flare can be prevented. The uniformness of the light flux to be projected on the wafer 13 can thus be im- 45 proved. Therefore, with desired light rays 24 passing through the projection optical system 12, a pattern of desired shape can be produced on the wafer 13 at a high precision. The reliability of a device to be produced by the stepper of Figure 1 can be improved.

[0050] Further, with the provision of cooling means having Petiter elements 30a and 30b in close proximity to the recesses 28 and 29, the recesses 28 and 29 thated as a result of absorption of the light rays 25 can be cooled threeby Thus, any deformation of the barred 21 55 due to heat can be reduced, and degradation of the optical performance of the projection optical system 12 can be prevented.

[0051] Next, a second embodiment of the present inrention will be described in conjunction with the drawings. Also in the second embodiment, description will be made on an example of a stepper having an optical unit according to the present invention.

[0052] Major structures of the stepper and the projection optical system as an optical unit, of the second embodiment are essentially the same as those of the first embodiment. The second embodiment differs from the first embodiment in respect to the light absorbing structure 26 and the cooling means 27 of Figure 2. These components will be mainly described below. In the drawings which illustrate the second embodiment, the structural elements substantially corresponding to those of the first embodiment are denoted by like numerals.

[0053] Figure 6 shows details of a light absorbing structure 28 according to the second embodiment. The light absorbing structure 26 comprises a groove-like member 31 having a wedge-like sectional shape and being formed to extend over the entire circumference of the inside circumferential surface 21s of the barrel 21. The groove-like member 31 has its tip ends formed with shape gedge, and it is hold fixed at the bottom.

[0054] Figure 7 is an enlarged sectional view of the groove-like member 31 in this embodiment. The groove-like member 31 provide metal faces 31 a of the groove-like member 31 provide metal reflection surfaces. By forming the side faces 31 as or-flection surfaces in this manner, as shown in Figure 7. When unwanted light tays 25 are incident on the light absorbing structure 26 comprising the groove-like member 31, the light rays 25 are repeatedly reflected and are directed to the bottom 32 of each groove. Thus, the light rays can be absorbed at the bottom 32.

§ 10055] As shown in Figure 8, disposed on the outside circumference of the barrel 2 is a lim-like heart radiation plate 33 which is mounted in close proximity to the light absorbing structure 26 comprising the groove-like member 31. The heat radiation plate 33 is formed to extend 0 through the entire outside circumference of the barrel 21. It functions as ocoling means 27 for cooling the wodges of the groove-like member 31 as being heated by the absorption of the light rays 25.

[0055] Namely, the healt from the groove-like member of 31 being heated by absorption of light rays 25 is transferred to the heat radiation plate 33 through the barrel 21. Then, it can be radiated effectively, by means of interest tradiation plate 33 which is formed with first and thus with an enlarged surface area [9057] in accordance with the second embodiment of

the present invention as described above, light rays 25 incident on the diffractive optical element 22 are diffract od into desired first order offiraction light (light rays 24), while unwanted light rays 25 produced and diffracted in a direction different from the light rays 24 are absorbed by the light absorbing structure 26 which has a groove-like member 31 and which is provided in the advancement direction of the unwanted light rays 25. Through

the absorption of the unwanted light 25, it can be removed from the projection optical system 12.

[0058] As a result, the light rays 25 which may cause irregular reflection within the projection optical system 12 can be removed and, therefore, production of ghost or flare can be prevented. The uniformness of the light flux to be projected on the water 13 can thus be improved. Therefore, with desired light rays 24 passing through the projection optical system 12, a pattern of desired shape can be produced on the water 13 at a high precision. The reliability of a device to be produced by the stapper of Figure 1 can be improved.

[0059] Further, with the provision of the fin-like heat radiation plate 30 utside the barrel 21, the groove-like member 31 heated as a result of absorption of the light 15 rays 25 can be cooled thereby Thus, any deformation of the barrel 21 due to heat can be reduced, and degradation of the optical performance of the projection optical system (2.6 an be orewinder).

[0060] The heat radiation plate 33 may be used also 20 in the first embodiment as the cooling means 27. The Patier elements 30 and 30b may be used also in the second embodiment as the cooling means 27. Further, in the first and second embodiments, the cooling means 27 may be structured into a water cooling system, with the addition of piping means in proximity to the optical absorption means 28, for exemple.

[0061] Further, as shown in Figure 8, an additional optical absorption structure 26' may be provided below the lens 24. With the provision of such optical absorption means 26' at that position, even if unwanted light rays 34 being diffracted in directions other than the direction of the light rays 25 pass through the optical lens 24, the light rays 24 passing through the optical lens 24 and being deflected (refracted) toward the inside circumferential surface 21a of the barrel 21 can be removed thereby Also in that occasion, additional cooling means 27' may be provided outside the barrel 21, in close proximity to the optical absorption structure 26', by which the optical absorption structure 26' heated through the absorption 40 of the light rays 33 can be cooled. In the manner as described, simulations may be made on the basis of the wavelength of the light source 1 as well as the design values of the diffractive optical element 22 and of the optical lenses 23 and 24, and the optical absorption 45 means 26 may be provided in the portion where incidence of unwanted light rays is expected. With this arrangement, these unwanted light rays can be absorbed effectively.

[0062] Next, an embodiment of a semiconductor device manufacturing method which uses a stepper having been described with reference to Figure 1, will be explained

[0063] Figure 10 is a flow chart of procedure for manufacture of microdevices such as semiconductor chips 55 (e.g. ICs or LSIs), liquid crystal panels, or CCDs, for example

[0064] Step 1 is a design process for designing a cir-

cuit of a semiconductor device. Step 2 is a process for making a mask on the basis of the circuit pration design. Step 3 is a process for preparing a wafer by using a material such as silicon. Step 4 is a wafer process (called a pre-process) wherein, by using the so prepared mask and wafer, circuits are practically formed on the wafer through ithorgaphy. Step 5 subsequent to this is an assembling step (called a post-process) wherein the wafer having been processed by step 4 is formed into semior conductor chips. This step includes an assembling (dicing) process. Step 6 is an inspection step wherein operation check, durability dreck and so on for the semi-

conductor devices provided by step 5, are carried out.

With these processes, semiconductor devices are completed and they are shipped (step 7).

[0065] Figure 11 is a flow chart showing details of the water process.

[0066] Step 11 is an oxidation process for oxidizing the surface of a wafer. Step 12 is a CVD process for forming an insulating film on the wafer surface. Step 13 is an electrode forming process for forming electrodes upon the wafer by vapor deposition. Step 14 is an ion implanting process for implianting ions to the wafer. Step 15 is a resist process for applying a resist (choiceonsist of the variety of the process for applying a resist (choiceonsist).

5 fb is a recist process for applying a resist (photosons-tive material) to the waler. Step 16 is an exposure process for printing, by exposure, the circuit pattern of the mask on the water through the exposure apparatus described above. Step 17 is a developing process for developing the exposed waler. Step 18 is an etching process for removing portions other than the developed resist image. Step 19 is a resist separation process for separating the resist material remaining on the wafer all or being subjected to the etching process. By repeating 5 these processes, circuit patterns are superposedly formed on the wafer.

(0067) Where this manufacturing method is used, at step 16, uniform illumination light having various optical aberrations corrected can be projected to the wafer surface, with use of the stepper according to this embodiment of the present invention and with a large latitude. Therefore, a large-integration semiconductor device can be produced easily and stably. Here, it is to be note that this manufacturing method may be used for the difference of the differe

[0068] While the lirst and second embodiments have been described with reference to examples of a slepper as an optical instrument having a diffractive optical element 22, the present invention is not limited to this. For example, as shown in Figure 9, the optical unit may be used in a portion of lenses constituting a television camera (CCD camera).

[0069] In the TV camera shown in Figure 9, there are lens groups 102 - 105 before a photoelectric converting element (CCD) 101, that is, on the target side. Here, denoted at 102 is a focusing lens group, and denoted at 103 is a variation lens group. Denoted at 104 is a com-

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pensator lens group, and dented at 105 is a relay lens group

[0070] The locusing lens group 102 is held by a focusing lens barrel, and it can be moved along the optical axis direction. With this movement of the locusing lens group, the focusing operation is performed. Also, through movements of the variation lens group 104, the compensator lens group 104, the zooming operation is performed. An image of a subject to be pholographed is imaged on the photoelectric converting element 101 after the relay lens group 105, by which a video image is produced.

[0071] In the TV camera of the structure described above, the difficative optical element 22 according to the present invention is fixedly mounted in front of the compensator lens group 104, for example. This enables that a portion of a lens group, which should otherwise be required for suppressing the production of aberration, can be substituted by the diffractive optical element 22, this incorporating the diffractive optical element 22 into the optical system of the television camera, the foldan umber of lenses of the optical system camera, the stall number of lenses of the optical system as a whole can be reduced. This accomplishes a TV camera of smaller size and with a simple structure. Also, the manufacturing cost can be lowered significantly.

[0072] The light absorbing structure 26 of the present invention is provided on the inside surface of the barrel, for holding the compensator lens group 104, and in proximity to the diffractive optical element 22. Also, there is cooling means 27 at the outside circumference of the 30 barrel. Unwanted light rays diffracted by the diffractive optical element 22 and directed to the light absorbing structure 26 are absorbed thereby. The light absorbing structure 26 being heated by absorption of light can be cooled by the cooling means 27.

[0073] Also, there is a light absorbing structure 26 disposed between two lenses, constituting the focusing lens group 102 in this mainner, the light absorbing structure 26 is operable not only to directly absorb unwanted light rays produced by the difficative optical element 22 40 bit also to absorb unwanted light rays from the lens to remove them. Also in that occasion, cooling means 27 may desirably be provided in close proximity to the light absorbing structure 26. Here, it it to be noted that the structure of the television camera described above may 45 be applied to a photographic camera using an ordinary photoceansitive material.

[0074] Next, a third embodiment of the present invention will be described in conjunction with the drawings. Also in the third embodiment, description will be made on an example of a stepper having an optical unit according to the present invention.

[0075] Major structures of the stopper and the projection optical system as an optical unit, of the third ombodiment are essentially the same as those of the second embodiment. The third embodiment differs from the second embodiment in respect to the light absorbing structure 26 shown in Figure 6, and description will be made mainly to this point of structure.

[0076] Figure 12 shows details of a light absorbing structure 28 according to the third embodiment. The light absorbing structure 26 comprises a grove-like member 201 of approximately rectangular sectional chape and being formed to extend substantially through the entire circumference of the inside circumferential surface 21a of the barrel 21. The groove-like member 201 has bottoms 202 each being defined by a surface having a certain area, not by a sharp edge.

[0077] Figure 13 is a sectional view showing the groove-like member 201 in enlargement. In this embodiment, the groove-like member 201 is made of a metal material, and the side faces 201a of the groove-like member 201 provide metal reflection surfaces.

[0078] The reflection factor of the metal reflection surtace is made low with respect to the wavelength of incident light 23. This can be done, for example, by despecting a desired optical film there of by fourphy processor in the same during a cutting and processing operation, for example, in that occasion, the light rays 25 incident thereupon are attenuated through multiple reflection at the miside surface of the groove-like member 201, but light rays impriging on the bottom 202 may then be mulsiplo-reflected and may emerge from the light absorbing structure as light rays 23. Even in that occasion, however, they can be attenuated to a level that does not influence the ghost of flate, for example.

[0079] In this embodiment, the width of each groove of the groove-like member 201 decreases toward its bottom 202. However, this width may be kept substantially constant, toward the bottom 201. Also, the bottom 202 may have a curved surface, not a flat surface.

[0080] Further, also in the first and second embodiments, even when a portion of the converged light rays leaks from the optical absorption structure, there occurs no inconvenience if the light rays are sufficiently attenuated to a level that does not cause phost or flare.

[0081] While the invention has been described with reference to the structures disclosed herein, it is not confined to the details set forth and this application is intended to cover such modifications or changes as may come within the purposes of the improvements or the scope of the following claims.

#### Claims

An optical unit, comprising:

an optical element for deflecting light incident thereon toward different directions; and attenuating means for attenuating light deflected in a predetermined direction, of the different directions.

An optical unit, comprising:

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means for holding an optical telement operable to deflect a portion of light incident thereon toward a predetermined direction and having a function that an unwanted light in another portion of the light incident thereon is direction of different from the pradetermined direction of different from the pradetermined direction.

attenuating means operable to converge at least a portion of the unwanted light toward a predetermined region through multiple reflection, thereby to attenuate the same.

- An optical unit according to Claim 1 or 2, further comprising cooling means for cooling said attenuating means.
- An optical unit according to any one of Claims 1 -3, wherein said attonuating means has a function for converging the light loward a predetermined region through multiple reflection.
- An optical unit according to any one of Claims 1 -5, wherein said optical element comprises a diffractive optical element.
- An optical unit according to Claim 5, wherein said diffractive optical element has a diffraction pattern formed with a step-like shape.
- An optical unit according to any one of Claims 3 30 6, wherein the light deflected toward the predetermined direction is a positive first order or negative first order diffraction light of the light deflected by said optical element.
- An optical unit according to any one of Claims 1-7, wherein said attenuating means comprises light absorbing means having a rocess of hom-like sectional shape with lts inside wall face formed as a reflection surface.
- An optical unit according to any one of Claims 1 7, wherein said attenuating means comprises light absorbing means having a groove-like member with its side face formed as a reflection surface.
- 10. An optical unit according to any one of Claims 1 9, wherein said optical element is fixed y or movably held in a barrel, and wherein said attenuating means is provided over the whote circumference of 50 the inside circumferental surface of said barrel.
- An optical unit according to any one of Claims 1 -10, wherein said optical unit has a pturality of light absorbing means.
- An optical unit according to any one of Claims 3 wherein said cooling means comprises an air

cooling system

- An optical unit according to any one of Claims 3 -11, wherein said cooling means comprises a water cooling system.
- An optical unit according to any one of Claims 3 -11, wherein said cooling means comprises a Petter device.
- 15. An optical instrument having an optical unit as recited in any one of Claims 1 - 14, for projecting light to a photosensitive material through said optical unit.
- 16. An optical instrument having an optical unit as recited in any one of Claims 1 14, for projecting light to a photoelectric converting element through said optical unit.
- 17. An exposure apparatus, comprising:

an ittumination optical system; a projection optical system; and an optical unit as recited in any one of Claims 1 - 14, wherein said optical unit is incorporated

- 1 14, wherein said optical unit is incorporated into one of said illumination optical system and said projection optical system as a portion thereof, so that a predetermined pattern is projected onto a surface to be illuminated, whereby the pattern is printed thereon.
- A device manufacturing method, comprising the steps of:

applying a photosensitive material to a wafer; exposing the wafer having the photosensitive material applied thereto, with a device pattern by use of an exposure apparatus as recited in Claim 17:

developing the exposed water; and manufacturing a device from the exposed wafer.

45 19. An optical device, comprising:

an optical element for deflecting a first portion of a light beam incident thereon in a first direction and a second portion of said light beam in a second direction;

attenuating means for attenuating one of said first and second deflected portions of said light beam.

20. An optical device according to claim 19, wherein said attenuating means is operable to converge said one deflected portion toward a predetermined region by multiple reflection. 15

- 15 EP 0

  21. An optical device according to claim 19 or claim 20, wherein said optical element comprises a diffractive cotical element.
- 22. An attenuating device for a barrel of an optical system wherein a plurality of optical elements are arranged sequentially along an optical axis extending through the barrel, the attenuating device comprising a number of circumferentally-actionding grooves having openings in the radially inward direction of the barrel.
- An attenuating device according to claim 22, wherein the grooves have reflective sidewalls.
- An attenuating device according to claim 22 or claim 23, wherein the grooves are tapered in the radially outward direction of the barret.
- An attenuating device according to any of claims 22 20 to 24, further comprising cooling means for cooling said attenuating device.
- 26. An exposure apparatus comprising an illumination optical system for illuminating a first object and a 25 projection optical system for projecting a pattern of said first object onto a second object, wherein said illumination optical system or said projection optical system comprises:

an optical element for deflecting a first portion of a light beam incident thereon in a first direction and a second portion of said light beam in a second direction;

a second direction, attenuating means for attenuating one of said 35 first and second deflected portions of said light beam.

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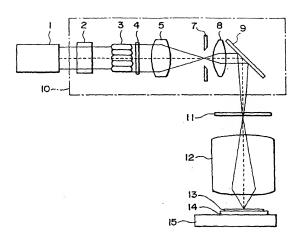
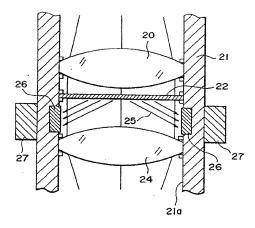


FIG. I



F1G. 2

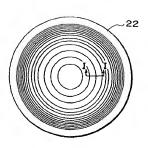


FIG. 3A

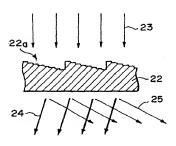


FIG. 3B

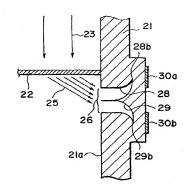
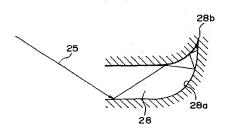


FIG. 4



F I G. 5

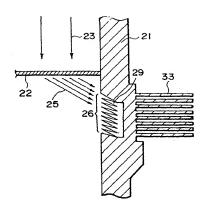
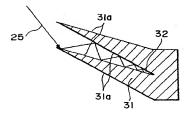
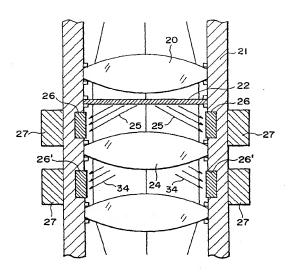


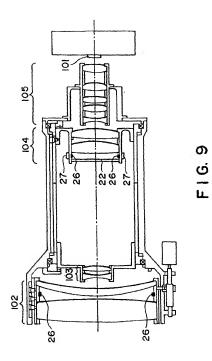
FIG. 6



F1G. 7



F I G. 8



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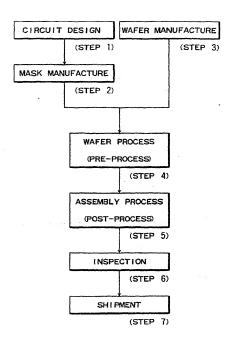


FIG. 10

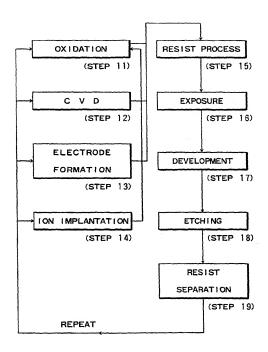


FIG. 11

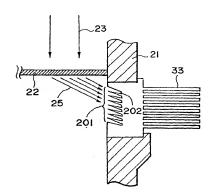


FIG. 12

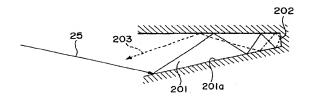


FIG. 13

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(12)

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- (71) Applicant: CANON KABUSHIKI KAISHA Tokyo (JP)

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(11)

- (72) inventor: Tsuji, Toshihiko, c/o Canon Kabushiki Kaisha Tokyo (JP)
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#### Projection optical system for projection exposure apparatus (54)

(57) A projection tens of a reduction projection exposure apparatus (stepper) includes a diffractive optical element (22) which reduces aberrations and deflects light towards different directions. Light deflected into unwanted directions (25) which are not in a desired direction used for image formation are attenuated by a light absorbing structure (26) to avoid ghost images or flare in the projected images. Cooling means (27) are provided for cooling the attenuating means (26) and ensure deformation of the barrel (21) due to heat is reduced. The attenuating means (26) preferably operate through multiple reflections.

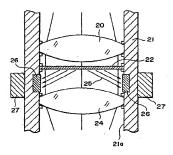


FIG. 2

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## EUROPEAN SEARCH REPORT

Application Number EP 99 30 7717

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-	* column 11, line 1	11 - line 44; figure 5	*	
×	28 December 1971 (1	RRETT HAROLD L ET AL) 1971-12-28) - line 10; figure 1 *	1,8	
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	The present search report has	been drawn up for all claims		
	Place of search	Date of completion of the search	4	Examiner
	BERLIN	28 August 2003	vor	Moers, F
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EP 99 30 7717

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